



2014 Bond Technology Infrastructure Spending Balance as of August 21, 2015

The following is the 2014 Bond Technology Infrastructure Spending Balance as of August 21, 2015.

To assure accountability and transparency, every purchase order and expenditure by each Bond goal is being tracked, then balanced with the Finance department's records.

Bond Goal	Bond Goal Description	Balance	% Spent	2014 Bond Allocation
1.1	Install High Speed Wireless Access Infrastructure	\$3,170,735.79	75.49%	\$12,934,270.00
2.1	Install Network Electronics Infrastructure	\$15,631,755.28	45.51%	\$28,689,853.45
3.1	Upgrade Fiber and Cabling Connectivity	\$2,595,711.28	44.42%	\$4,670,150.00
3.2	Upgrade Electrical Power and Air Conditioning	\$989,512.99	80.09%	\$4,969,862.99
4.1	Build a Virtualized Server Data Center	\$3,003,361.58	3.28%	\$3,105,236.33
4.2	Install a Storage Area Network (SAN)	\$4,684,504.41	0.00%	\$4,684,504.41
4.3	Co-Locate Data Center at an External Facility	\$651,096.30	6.77%	\$698,413.20
4.4	Build Backup, Recovery, and Business Continuity	\$572,000.21	65.55%	\$1,660,506.21
5.1	Replace Telephone System w/VoIP Communications	\$7,469,293.81	0.00%	\$7,469,293.81
5.2	Replace Administrative Staff Technology	\$6,568,102.75	18.89%	\$8,097,716.00
5.3	Replace Network Printers and Print Servers	\$4,182,715.00	0.00%	\$4,182,715.00
6.1	Install Technology Infrastructure in New Schools	\$1,822,437.73	45.03%	\$3,315,248.00
7.1	Design Contingency	\$5,025,928.89	15.01%	\$5,913,443.89
Total:		\$56,367,156.02	37.64%	\$90,391,213.29